

# DOSEMI

# IGBT

## DG100X07T2

### 650V/100A IGBT with Diode

### General Description

DOSEMI IGBT Power Discrete provides ultra low conduction loss as well as low switching loss. They are designed for the applications such as general inverters and UPS.

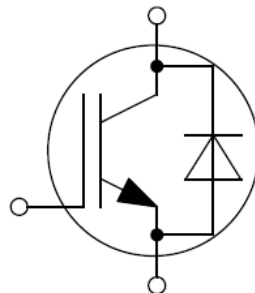
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- Low switching loss
- Maximum junction temperature 175°C
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD
- Lead free package

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
$V_{CES}$	Collector-Emitter Voltage	650	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^{\circ}\text{C}$	200	A
	@ $T_C=130^{\circ}\text{C}$	100	A
$I_{CM}$	Pulsed Collector Current $t_p$ limited by $T_{jmax}$	400	A
$P_D$	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	1071	W

**Diode**

Symbol	Description	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	650	V
$I_F$	Diode Continuous Forward Current @ $T_C=25^{\circ}\text{C}$	200	A
	@ $T_C=120^{\circ}\text{C}$	100	A
$I_{FM}$	Diode Maximum Forward Current $t_p$ limited by $T_{jmax}$	400	A

**Discrete**

Symbol	Description	Values	Unit
$T_{jop}$	Operating Junction Temperature	-40 to +175	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to +150	$^{\circ}\text{C}$
$T_S$	Soldering Temperature, 1.6mm from case for 10s	260	$^{\circ}\text{C}$

**IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=100\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.45	1.90	V
		$I_C=100\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.60		
		$I_C=100\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.70		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1.60\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.1	5.8	6.5	V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA
$R_{Gint}$	Internal Gate Resistance			2.0		$\Omega$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		11.6		nF
$C_{res}$	Reverse Transfer Capacitance			0.23		nF
$Q_G$	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.69		$\mu\text{C}$
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=100\text{A}, R_G=3.3\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		40		ns
$t_r$	Rise Time			20		ns
$t_{d(off)}$	Turn-Off Delay Time			192		ns
$t_f$	Fall Time			40		ns
$E_{on}$	Turn-On Switching Loss			0.44		mJ
$E_{off}$	Turn-Off Switching Loss			2.00		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=100\text{A}, R_G=3.3\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		48		ns
$t_r$	Rise Time			24		ns
$t_{d(off)}$	Turn-Off Delay Time			208		ns
$t_f$	Fall Time			52		ns
$E_{on}$	Turn-On Switching Loss			0.68		mJ
$E_{off}$	Turn-Off Switching Loss			2.68		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=100\text{A}, R_G=3.3\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$		52		ns
$t_r$	Rise Time			24		ns
$t_{d(off)}$	Turn-Off Delay Time			216		ns
$t_f$	Fall Time			60		ns
$E_{on}$	Turn-On Switching Loss			0.78		mJ
$E_{off}$	Turn-Off Switching Loss			2.80		mJ
$I_{SC}$	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=360\text{V}, V_{CEM} \leq 650\text{V}$		500		A

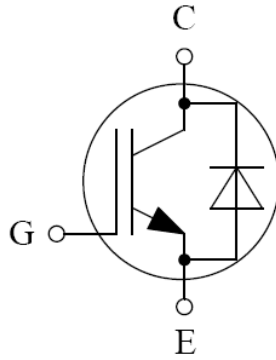
**Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_F$	Diode Forward Voltage	$I_F=100\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.55	2.00	V
		$I_F=100\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.50		
		$I_F=100\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.45		
$Q_r$	Recovered Charge	$V_R=300\text{V}, I_F=100\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		4.6		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			99		A
$E_{rec}$	Reverse Recovery Energy			1.32		mJ
$Q_r$	Recovered Charge	$V_R=300\text{V}, I_F=100\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		8.6		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			121		A
$E_{rec}$	Reverse Recovery Energy			2.37		mJ
$Q_r$	Recovered Charge	$V_R=300\text{V}, I_F=100\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		9.9		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			127		A
$E_{rec}$	Reverse Recovery Energy			2.64		mJ

**Discrete Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

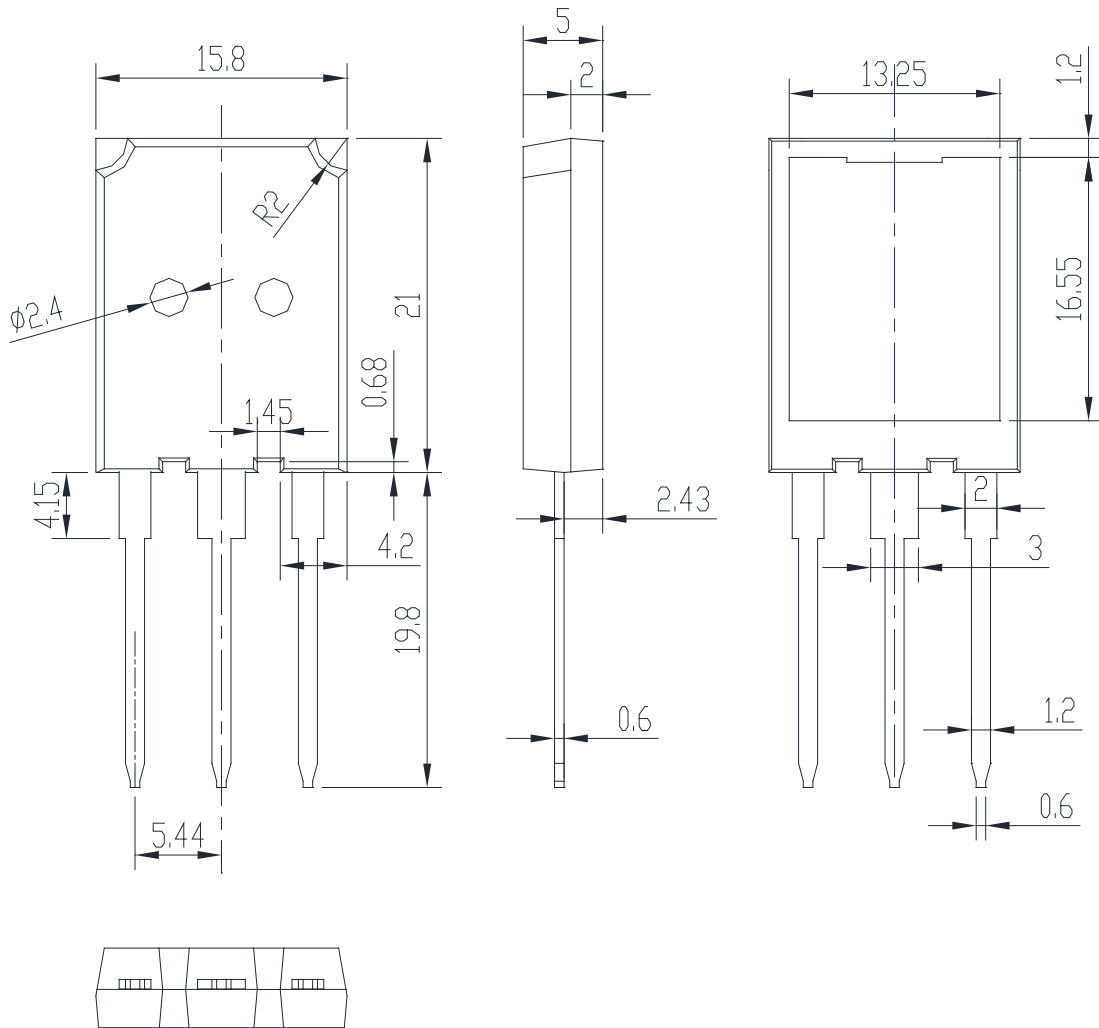
Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{thJC}$	Junction-to-Case (per IGBT)			0.140	K/W
	Junction-to-Case (per Diode)			0.262	
$R_{thJA}$	Junction-to-Ambient		40		K/W

### Circuit Schematic



### Package Dimensions

Dimensions in Millimeters



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